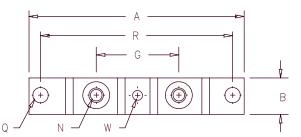
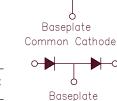
Schottky PowerMod











D=Doubler Notes: Baseplate: Nickel plated copper

Dim. Ir	nches	Millimeters		
Min.	Max.	Min.	Max.	Notes
B 0.700 C E 0.120 F 0.490 G 1.375	0.680 0.130 0.510 BSC	17.78 3.05 12.45 34.92	20.32 17.28 3.30 12.95 2 BSC	
H 0.010 N Q 0.275 R 3.15 U 0.600 V 0.312 W 0.180	0.290 0 BSC 0.340	6.99 80.0 15.24 7.92	7.37 1 BSC 8.64	1/4-20 Dia.

Microsemi Catalog Number			Repetitive Peak Reverse Voltage
CPT60035* CPT60040* CPT60045*	MBRP60035CTL	35V 40V 45V	35V 40V 45V
*Add Suf	fix A for Commo	on Anode, D for	Doubler

- Schottky Barrier Rectifier
- Guard Ring Protection
- 600 Amperes/35 to 45 Volts
- 175°C Junction Temperature
- Reverse Energy Tested
- ROHS Compliant

Electrical Characteristics

Average forward current per pkg Average forward current per leg Maximum surge current per leg Maximum repetitive reverse current per leg |R(OV) 2 Amps Max peak forward voltage per leg |VFM 0.65 Vol Max peak forward voltage per leg Max peak forward voltage per leg Max peak reverse current per leg Max peak reverse current per leg Typical junction capacitance per leg

F(AV) 600 Amps F(AV) 300 Amps IFSM 6000 Amps 0.65 Volts VFМ 0.52 Volts ^IRM 75 mA ^IRM 8.0 mA C_{J} 14000 pF

 ^{T}C = 139°C, Square wave, $^{R}\Theta JC$ = 0.10°C/W ^{T}C = 139°C, Square wave, $^{R}\Theta JC$ = 0.20°C/W 8.3ms, half sine, TJ = 175°C f = 1 KHZ, 25°C, 1 $^\mu$ sec square wave † FM = 300A: TJ = 25°C

TFM = 300A:TJ = 175°C VRRM,TJ = 125°C* VRRM,TJ = 25°C $V_R = 5.0V, T_C = 25^{\circ}C$

*Pulse test: Pulse width 300 µsec, Duty cycle 2%

Thermal and Mechanical Characteristics

Storage temp range Operating junction temp range Max thermal resistance per leg Max thermal resistance per pkg Typical thermal resistance (greased) Terminal Torque Mounting Base Torque (outside holes) Mounting Base Torque (center hole) center hole must be torqued first Weight

TSTG ΤJ R OJC ROJC Recs

-55℃ to 175℃ -55°C to 175°C 0.20°C/W Junction to case 0.10°C/W Junction to case 0.08°C/W Case to sink 35-40 inch pounds 30-40 inch pounds 8-10 inch pounds

2.8 ounces (78 grams) typical



CPT60035 - CPT60045

Figure 1 Typical Forward Characteristics — Per Leg

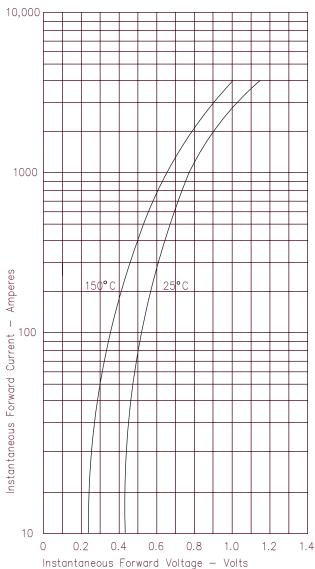


Figure 2 Typical Reverse Characteristics — Per Leg

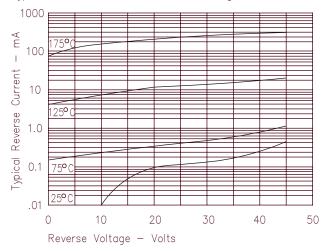


Figure 3
Typical Junction Capacitance — Per Leg

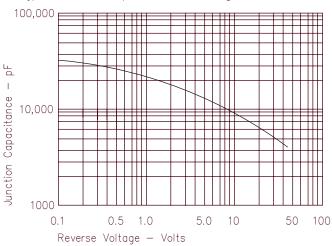


Figure 4
Forward Current Derating — Per Leg

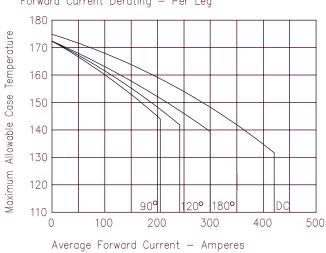
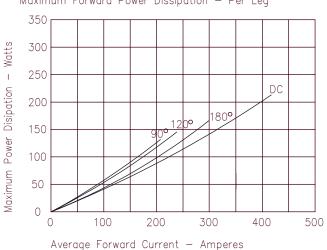


Figure 5 Maximum Forward Power Dissipation — Per Leg



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